

Product Technical Data Sheet

AG Diamond Brush

Ideally suited for any processors, chipsets, GPUs and other subassemblies. It is characterised by good thermal conductivity owing to the use of diamond dust. A special brush facilitates the paste application. Diamond dust content: 10%

Application:

- Ideal for any processors, chipsets, GPUs and other subassemblies

Physicochemical properties:

Parameters	UoM	Result
Heat transfer coefficient at a temp. of 0-150°C	W/mK	> 4
Operating temperature range	°C	-40 - 300
Density	g/cm ³	>2,5

Packagings:

Volume	Collective packaging	Item Code
4 g	5	ART.AGT-123

Warehousing:

Store in a well-ventilated, cool and dry place. Keep containers tightly closed when not in use. Protect against sunlight exposure.

Data contained in this document are consistent with the current state of our knowledge. They describe typical product properties and applications. However, it is up to the user to examine the suitability of this product for specific applications. We deny liability for the obtained results on the grounds that application conditions lie beyond our control.